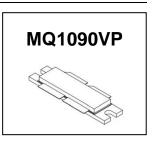
## **MQ1090VP LDMOS TRANSISTOR**

### 1000W, 50V High Power RF LDMOS FETs

#### **Description**

The MQ1090VP is a 1000-watt capable, high performance, internally matched LDMOS FET, designed for narrow band avionics applications with frequencies 1030/1090MHz.



Typical Avionics Performance (on innogration narrow band test fixture with device soldered):

Frequency:1030MHz,: Vds = 50 Volts, Idq = 100 mA, TA = 25 C

Pulse condition	Gp (dB)	P <sub>OUT</sub> (W)	η <sub>D</sub> @P <sub>OUT</sub> (%)
pulse width 100us	14.5	1100	56
duty cycle 10%	14.5	1100	30
pulse width 50us	14	1200	EC E
duty cycle 1%	14	1200	56.5

#### **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- · Internally Matched for Ease of Use
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Excellent thermal stability, low HCI drift
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

#### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	115	Vdc
GateSource Voltage	$V_{GS}$	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+55	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T,	+225	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case, Case Temperature			
80°C, 1000W Pout, Pulse width: 100us, duty cycle: 10%,	RθJC	0.02	°C/W
Vds=50 V, IDQ = 100 mA , Frequency at 1030MHz			

#### **Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

#### Table 4. Electrical Characteristics (TA = 25 C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics					
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	115			V

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(V <sub>GS</sub> =0V; I <sub>D</sub> =100uA)					
Zero Gate Voltage Drain Leakage Current			10	^	
$(V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V})$	I <sub>DSS</sub>	 	10	μΑ	
GateSource Leakage Current	1	 	1	^	
$(V_{GS} = 6 \text{ V}, V_{DS} = 0 \text{ V})$	I <sub>GSS</sub>		ı	μΑ	
Gate Threshold Voltage	$V_{GS}(th)$	1.6		V	
$(V_{DS} = 50V, I_{D} = 600 \text{ uA})$	V <sub>GS</sub> (tn)	 1.0		V	
Gate Quiescent Voltage	V	2.0		V	
(V <sub>DD</sub> = 50 V, I <sub>DQ</sub> = 100 mA, Measured in Functional Test)	$V_{GS(Q)}$	3.0		V	

Functional Tests (In Innogration test fixture, 50 ohm system):  $V_{DD} = 50 \text{ Vdc}$ ,  $I_{DQ} = 100 \text{ mA}$ , f = 1030 MHz, Pulse CW Signal Measurements. (Pulse Width=100  $\mu$ s, Duty cycle=10%), Pin=46dBm

Power Gain	Gp		14		dB
Output Power	P <sub>out</sub>		1000		W
Drain Efficiency@Pout	η <sub>D</sub>	——	56	——	%
Input Return Loss	IRL	——	-7	——	dB

Figure 1: 1030MHz Pulsed CW gain and efficiency as a Function of Output Power Pulse width 100us and duty cycle 10%

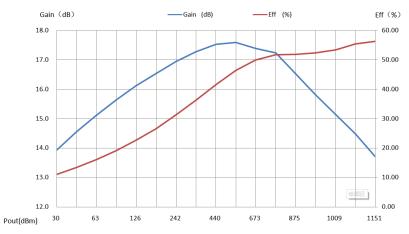
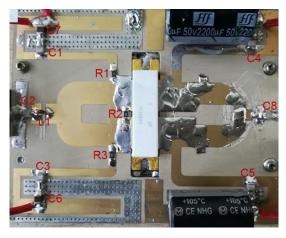


Figure 2: Test fixture photo(1030MHz)

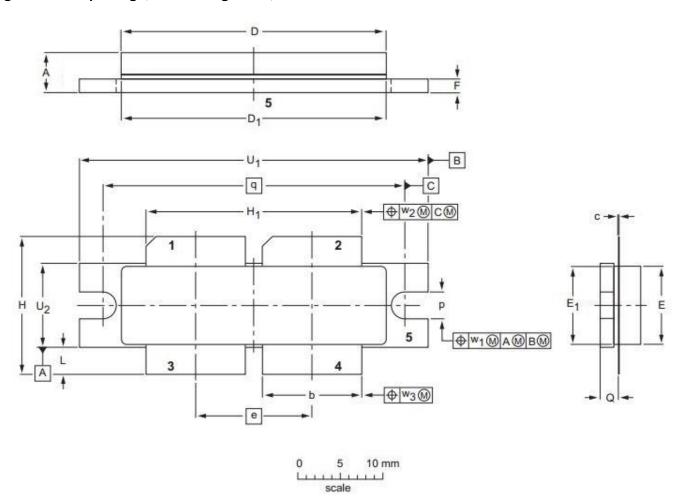


BOM of 1030MHz fixture (PCB 25mil TC600 from Arlon)						
	C1,C2,C3,C4,C5,C8	56PF	ATC800B			
	C6,C7	10UF				
	R1,R2,R3	10 Ω				
	L1	1turns	Diameter=3mm			

# **MQ1090VP LDMOS TRANSISTOR**

### **Package Outline**

Flanged ceramic package; 2 mounting holes; 4 leads (1, 2—DRAIN, 3, 4—GATE, 5—SOURCE)



UNIT	A	b	С	D	D <sub>1</sub>	е	E	E <sub>1</sub>	F	Н	H <sub>1</sub>	L	р	Q	q	U <sub>1</sub>	U <sub>2</sub>	W <sub>1</sub>	W <sub>2</sub>	W <sub>2</sub>
mm	4.7	11.81	0.18	31.55	31.52	12.72	9.50	9.53	1.75	17.12	25.53	3.48	3.30	2.26	35.56	41.28	10.29	0.25	0.51	0.25
mm	4.2	11.56	0.10	30.94	30.96	13.72	9.30	9.27	1.50	16.10	25.27	2.97	3.05	2.01	33.30	41.02	10.03	0.25	0.51	0.25
inches	0.185	0.465	0.007	1.242	1.241	0.540	0.374	0.375	0.069	0.674	1.005	0.137	0.130	0.089	1 100	1.625	0.405	0.01	0.02	0.01
inches	0.165	0.455	0.004	1.218	1.219	0.540	0.366	0.365	0.059	0.634	0.995	0.117	0.120	0.079	1.400	1.615	0.395	0.01	0.02	0.01

OUTLINE		REFERENCE	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	1000E BATE
PKG-D4E					03/12/2013

## **MQ1090VP LDMOS TRANSISTOR**

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#### **Revision history**

Table 6. Document revision history

Date	Revision	Datasheet Status
2017/11/8	Rev 1.0	Preliminary Datasheet Creation

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